Monolithic Amplifier

PGA-103+

 50Ω 0.05 to 4 GHz

The Big Deal

- Ultra High IP3
- Broadband High Dynamic Range without external Matching Components
- May be used as a replacement for RFMD SPF-5189Z^{a,b}



SOT-89 PACKAGE

Product Overview

PGA-103+ (RoHS compliant) is an advanced wideband amplifier fabricated using E-PHEMT technology and offers extremely high dynamic range over a broad frequency range and with low noise figure. In addition, the PGA-103+ has good input and output return loss over a broad frequency range without the need for external matching components and has demonstrated excellent reliability. Lead finish is SnAgNi. It has repeatable performance from lot to lot and is enclosed in a SOT-89 package for very good thermal performance.

Key Features

Feature	Advantages
Broad Band: 0.05 to 4.0 GHz	Broadband covering primary wireless communications bands: Cellular, PCS, LTE, WiMAX
Ultra High IP3 Versus DC power Consumption: 45 dBm typical at 2 GHz at +5.0V Supply Voltage and only 97mA	The PGA-103+ provides excellent IP3 performance relative to device size and power consumption. The combination of the design and E-PHEMT Structure provides enhanced linearity over a broad frequency range as evidence in the IP3 being typically 20 dB above the P 1dB point. This feature makes this amplifier ideal for use in: • Driver amplifiers for complex waveform up converter paths • Drivers in linearized transmit systems • Secondary amplifiers in ultra High Dynamic range receivers
No External Matching Components Required	Unlike competing products, Mini-Circuits PGA-103+ provides Input and Output Return Loss of 11-24 dB over 0.4-4 GHz without the need for any external matching components
Low Noise Figure: 0.6 dB up to 1.0 GHz	A unique feature of the PGA-103+ which separates this design from all competitors is the low noise figure performance in combination with the high dynamic range.

a. Suitability for model replacement within a particular system must be determined by and is solely the responsibility of the customer based on, among other things, electrical performance criteria, stimulus conditions, application, compatibility with other components and environmental conditions and stresses. b. The RFMD SPF-5189Z part number is used for identification and comparison purposes only



For detailed performance specs

ISO 9001 ISO 14001 AS 9100 CERTIFIED
P.O. Box 350166, Brooklyn, New York 11235-0003 (718) 934-4500 Fax (718) 332-4661 The Design Engineers Search Engine 2 Provides ACTUAL Data Instantly at minicipouits.com IF/RF MICROWAVE COMPONENTS

Monolithic Amplifier

0.05-4 GHz

Product Features

- 5V/3V operation
- High IP3, 45 dBm typ. at 2 GHz, Vd=5V
- Low Noise Figure, 0.6 at 1 GHz; 0.9 dB at 2 GHz
- Gain, 11.0 dB typ. at 2 GHz
- P1dB 22.5 dBm typ. at 2 GHz at Vd=5V
- No external matching components required
- May be used as a replacement for RFMD SPF-5189Z^{a,b}

Typical Applications

- Base station infrastructure
- Portable Wireless
- CATV & DBS
- MMDS & Wireless LAN
- LTE



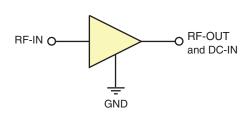
CASE STYLE: DE782 PRICE: \$1.99 ea. QTY. (20)

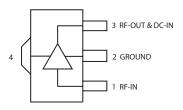
+RoHS Compliant The +Suffix identifies RoHS Compliance. See our web site for RoHS Compliance methodologies and qualifications

General Description

PGA-103+ (RoHS compliant) is an advanced wideband amplifier fabricated using E-PHEMT technology and offers extremely high dynamic range over a broad frequency range and with low noise figure. In addition, the PGA-103+ has good input and output return loss over a broad frequency range without the need for external matching components. Lead finish is SnAqNi. It has repeatable performance from lot to lot and is enclosed in a SOT-89 package for very good thermal performance.

simplified schematic and pin description





Function	Pin Number	Description
RF IN	1	RF input pin. This pin requires the use of an external DC blocking capacitor chosen for the frequency of operation.
RF-OUT and DC-IN	3	RF output and bias pin. DC voltage is present on this pin; therefore a DC blocking capacitor is necessary for proper operation. An RF choke is needed to feed DC bias without loss of RF signal due to the bias connection, as shown in "Recommended Application Circuit", Fig. 2
GND	2,4	Connections to ground. Use via holes as shown in "Suggested Layout for PCB Design" to reduce ground path inductance for best performance.

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Electrical Specifications⁽¹⁾ at 25°C, 50Ω, unless noted

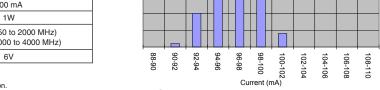
Parameter	Condition (GHz)		Vd=5V		Vd=3V	
		Min.	Тур.	Max.	Тур.	Units
Frequency Range		0.05		4.0		GHz
Gain	0.05		26.5		25.9	dB
	0.4		22.1		21.6	
	1.0	14.7	16.2	18.0	15.8	
	2.0		11.0		10.6	
	3.0		8.1		7.7	
	4.0		6.2		5.9	
Noise Figure	0.05		0.5		0.5	dB
	0.4		0.5		0.5	
	1.0		0.6		0.6	
	2.0		0.9		0.9	
	3.0		1.2		1.2	
	4.0		1.5		1.4	
nput Return Loss	0.05		6.7		6.1	dB
	0.4		11.3		10.4	
	1.0	10.0	13.0		12.0	
	2.0		12.8		13.0	
	3.0		13.7		13.0	
	4.0		15.0		14.2	
Output Return Loss	0.05		14.1		13.8	dB
·	0.4		23.8		25.5	
	1.0	10.0	21.8		30.6	
	2.0		20.6		26.4	
	3.0		17.2		20.8	
	4.0		16.0		19.2	
Reverse Isolation	1.0		21.2		20.5	dB
Output Power @1 dB compression(2)	0.05		20.0		15.4	dBm
·	0.4		21.5		18.2	
	1.0		22.5		18.7	
	2.0		22.5		19.3	
	3.0		22.9		20.0	
	4.0		23.2		20.7	
Output IP3	0.05		36.7		32.4	dBm
	0.4		39.0		34.1	
	1.0		41.9		34.5	
	2.0	40.0	44.6		35.6	
	3.0		44.3		35.6	
	4.0		45.4		35.3	
Device Operating Voltage		4.8	5.0	5.2	3.0	V
Device Operating Current			97	120	60	mA
Device Current Variation vs. Temperature			-178	.20	-54	μΑ/°C
Device Current Variation vs. Voltage			0.014		0.018	mA/mV
Thermal Resitance			36		36	°C/W

⁽¹⁾ Measured on Mini-Circuits Characterization test board TB-313. See Characterization Test Circuit (Fig. 1) (2) Current increases at P1dB

Absolute Maximum Ratings

Absolute maximum ridings				
Parameter	Ratings			
Operating Temperature (ground lead)	-40°C to 85°C			
Storage Temperature	-65°C to 150°C			
Operating Current at 5.0V	200 mA			
Power Dissipation at 5.0V	1W			
Input Power (CW)	+21 dBm (50 to 2000 MHz) +26 dBm (2000 to 4000 MHz)			
DC Voltage on Pin 3	6V			

Note:
Permanent damage may occur if any of these limits are exceeded.
Electrical maximum ratings are not intended for continuous normal operation.



DC Current Histogram, Vd=5V

For detailed performance specs & shopping online see web site

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Characterization Test Circuit

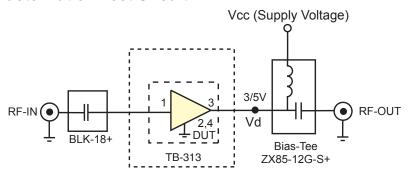
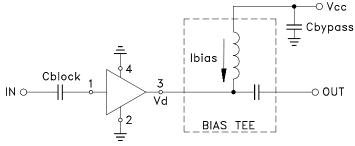


Fig 1. Block Diagram of Test Circuit used for characterization. (DUT tested on Mini-Circuits Characterization test board TB-313) Gain, Return loss, Output power at 1dB compression (P1 dB), output IP3 (OIP3) and noise figure measured using Agilent's N5242A PNA-X microwave network analyzer.

Conditions:

- 1. Gain and Return loss: Pin= -25dBm
- 2. Output IP3 (OIP3): Two tones, spaced 1 MHz apart, 5 dBm/tone at output.

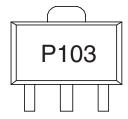
Recommended Application Circuit



Cblock=0.001µF, Bias-Tee=TCBT-14+, Cbypass=0.1µF

Fig 2. Evaluation board includes case, connectors, and components soldered to PCB

Product Marking



For detailed performance specs

Additional Detailed Technical Information additional information is available on our dash board. To access this information click here			
	Data Table		
Performance Data	Swept Graphs		
	S-Parameter (S2P Files) Data Set (.zip file)		
Case Style	DF782 (SOT 89) Plastic package, exposed paddle lead finish: tin/silver/nickel		
Tape & Reel	F55		
Standard quantities available on reel	7" reels with 20, 50, 100, 200, 500 or 1K devices		
Suggested Layout for PCB Design	PL-313		
Evaluation Board	TB-678-103+		
Environmental Ratings	ENV08T1		

ESD Rating

Human Body Model (HBM): Class 1A (250 to <500V) in accordance with ANSI/ESD STM 5.1 - 2001

Machine Model (MM): Class M1(25V) in accordance with ANSI/ESD STM5.2-1999



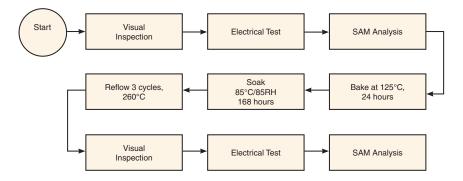
Attention

Observe precautions for handling electrostatic sensitive devices

MSL Rating

Moisture Sensitivity: MSL1 in accordance with IPC/JEDEC J-STD-020D

MSL Test Flow Chart



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